

Receipt date: 08/07/2008

Doc code :IDS

Doc description: Information Disclosure Statement (IDS) Filed

10817659 - GAU: 1795

PTO/SB/08a (03-08)

Approved for use through 04/30/2008. OMB 0651-0031

U.S. Patent and Trademark Office; U.S. DEPARTMENT OF COMMERCE

Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control number.

**INFORMATION DISCLOSURE  
STATEMENT BY APPLICANT**  
( Not for submission under 37 CFR 1.99)

Application Number	10817659
Filing Date	2004-04-02
First Named Inventor	Gregory J. Wilson
Art Unit	1795
Examiner Name	Nicholas A. Smith
Attorney Docket Number	63857.8157.US04

U.S.PATENTS						Remove	
Examiner Initial*	Cite No	Patent Number	Kind Code <sup>1</sup>	Issue Date	Name of Patentee or Applicant of cited Document	Pages,Columns,Lines where Relevant Passages or Relevant Figures Appear	Remove
	1						

If you wish to add additional U.S. Patent citation information please click the Add button.

U.S.PATENT APPLICATION PUBLICATIONS						Remove	
Examiner Initial*	Cite No	Publication Number	Kind Code <sup>1</sup>	Publication Date	Name of Patentee or Applicant of cited Document	Pages,Columns,Lines where Relevant Passages or Relevant Figures Appear	Remove
	1						

If you wish to add additional U.S. Published Application citation information please click the Add button.

FOREIGN PATENT DOCUMENTS							Remove	
Examiner Initial*	Cite No	Foreign Document Number <sup>3</sup>	Country Code <sup>2</sup>	Kind Code <sup>4</sup>	Publication Date	Name of Patentee or Applicant of cited Document	Pages,Columns,Lines where Relevant Passages or Relevant Figures Appear	T <sup>5</sup>
	1	2200800	JP		1990-08-09	Nippon Electric Co.		<input checked="" type="checkbox"/>
	2	2001-64795	JP		2001-03-13	Electroplating Engineers of Japan Limited		<input type="checkbox"/>
	3	11-350185	JP		1999-12-21	Electroplating Eng of Japan Co.		<input type="checkbox"/>

ALL REFERENCES CONSIDERED EXCEPT WHERE LINED THROUGH. /NS/

Receipt date: 08/07/2008

10817659 - GAU: 1795

**INFORMATION DISCLOSURE  
STATEMENT BY APPLICANT**  
( Not for submission under 37 CFR 1.99)

Application Number	10817659
Filing Date	2004-04-02
First Named Inventor	Gregory J. Wilson
Art Unit	1795
Examiner Name	Nicholas A. Smith
Attorney Docket Number	63857.8157.US04

4	2000-256896	JP		2000-09-19	Ebara Corp.		<input type="checkbox"/>
5	2000-087299	JP		2000-03-28	Ebara Corp.		<input checked="" type="checkbox"/>
6	7197299	JP		1995-08-01	Casio Computer Co. Ltd.		<input checked="" type="checkbox"/>
7	2004-097856	JP		2004-04-02	Masuda Shokai:KK		<input checked="" type="checkbox"/>

If you wish to add additional Foreign Patent Document citation information please click the Add button

**NON-PATENT LITERATURE DOCUMENTS**

Examiner Initials*	Cite No	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc), date, pages(s), volume-issue number(s), publisher, city and/or country where published.	T <sup>5</sup>
	1	Office Action issued by the Japanese Patent Office on May 26, 2008 in Japanese Patent Application No. 2003-500322.	<input checked="" type="checkbox"/>

If you wish to add additional non-patent literature document citation information please click the Add button

**EXAMINER SIGNATURE**

Examiner Signature	/Nicholas Smith/	Date Considered	12/04/2008
--------------------	------------------	-----------------	------------

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through a citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

<sup>1</sup> See Kind Codes of USPTO Patent Documents at [www.USPTO.GOV](http://www.USPTO.GOV) or MPEP 901.04. <sup>2</sup> Enter office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>3</sup> For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>4</sup> Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. <sup>5</sup> Applicant is to place a check mark here if English language translation is attached.